## 100mA CMOS Voltage Converter

## feATURES

- Simple Conversion of 5V to -5V Supply
- Output Drive: 100 mA
- Rout: $6.5 \Omega$ ( 0.65 V Loss at 100 mA )
- BOOST Pin (Pin 1) for Higher Switching Frequency
- Inverting and Doubling Modes
- Minimum Open Circuit Voltage Conversion Efficiency: 99\%
- Typical Power Conversion Efficiency with a 100mA Load: 88\%
- Easy to Use


## APPLICATIOOS

- Conversion of 5 V to $\pm 5 \mathrm{~V}$ Supplies
- Inexpensive Negative Supplies
- Data Acquisition Systems
- High Current Upgrade to LTC1044 or LTC7660


## DESCRIPTIOn

The LTC ${ }^{\circledR} 660$ is a monolithic CMOS switched-capacitor voltage converter. It performs supply voltage conversion from positive to negative from an input range of 1.5 V to 5.5 V , resulting in complementary output voltages of -1.5 V to -5.5 V . It also performs a doubling at an input voltage range of 2.5 V to 5.5 V , resulting in a doubled output voltage of 5 V to 11 V . Only two external capacitors are needed for the charge pump and charge reservoir functions.
The converter has an internal oscillator that can be overdriven by an external clock or slowed down when connected to a capacitor. The oscillator runs at a 10 kHz frequency when unloaded. A higher frequency outside the audio band can also be obtained if the BOOST pin is tied to $\mathrm{V}^{+}$.
The LTC660 contains an internal oscillator, divide-by-two, voltage level shifter and four power MOSFETs.

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## TYPICAL APPLICATION

Generating - 5 V from 5 V


Output Voltage vs
Load Current for $\mathrm{V}^{+}=5 \mathrm{~V}$


660 TA02
ABSOLUTE MAXIMUM RATINGS
(Note 1)
Supply Voltage ( ${ }^{+}$) ..... 6 V
Input Voltage on Pins 1, 6, 7 (Note 2)

$\qquad$
$-0.3 \mathrm{~V}<\mathrm{V}_{\mathrm{IN}}<\left(\mathrm{V}^{+}+0.3 \mathrm{~V}\right)$
Output Short-Circuit Duration to GND (Note 5) ..... 1 sec
Power Dissipation ..... 500 mW
Operating Temperature Range ..... $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage Temperature Range $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) ..... $300^{\circ} \mathrm{C}$

## PACKAGE/ORDER INFORMATION



Consult Factory for Industrial and Military grade parts.

## ELECTRICAL CHARACTERISTICS

$\mathrm{V}^{+}=5 \mathrm{~V}, \mathrm{C} 1$ and $\mathrm{C} 2=150 \mu \mathrm{~F}$, Boost $=$ Open, $\mathrm{C}_{0 S C}=0 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| SYMBOL | PARAMETER | CONDITIONS |  |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Supply Voltage | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k}$ | $\begin{aligned} & \text { Inverter, LV = Open } \\ & \text { Inverter, LV = GND } \\ & \text { Doubler, LV }=V_{\text {OUT }} \end{aligned}$ | $\bullet$ | $\begin{gathered} 3 \\ 1.5 \\ 2.5 \end{gathered}$ |  | $\begin{aligned} & 5.5 \\ & 5.5 \\ & 5.5 \end{aligned}$ | V V V |
| $I_{S}$ | Supply Current | No Load | $\begin{aligned} & \text { Boost }=\text { Open } \\ & \text { Boost }=V^{+} \end{aligned}$ | $\bullet$ |  | $\begin{aligned} & 0.08 \\ & 0.23 \end{aligned}$ | $\begin{gathered} 0.5 \\ 3 \end{gathered}$ | mA |
| IOUT | Output Current | $\mathrm{V}_{\text {OUT }}$ More Negative Than - 4 V |  | $\bullet$ | 100 |  |  | mA |
| R OUT | Output Resistance | $\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}$ (Note 3) |  | $\bullet$ |  | 6.5 | 10 | $\Omega$ |
| fosc | Oscillator Frequency | $\begin{aligned} & \text { Boost }=\text { Open } \\ & \text { Boost }=V^{+} \text {(Note 4) } \end{aligned}$ |  |  |  | $\begin{aligned} & 10 \\ & 80 \end{aligned}$ |  | kHz kHz |
|  | Power Efficiency | $\begin{aligned} & \hline R_{L}=1 \mathrm{k} \text { Connected Between } V^{+} \text {and } V_{\text {OUT }} \\ & R_{L}=500 \Omega \text { Connected Between } V_{\text {OUT }} \text { and } G N D \\ & I_{L}=100 \mathrm{~mA} \text { to } G N D \\ & \hline \end{aligned}$ |  | $\bullet$ | $\begin{aligned} & 96 \\ & 92 \end{aligned}$ | $\begin{aligned} & 98 \\ & 96 \\ & 88 \end{aligned}$ |  | \% \% $\%$ |
|  | Voltage Conversion Efficiency | No Load |  |  | 99 | 99.96 |  | \% |
|  | Oscillator Sink or Source Current | $\begin{aligned} & \text { Boost }=\text { Open } \\ & \text { Boost }=V^{+} \end{aligned}$ |  |  |  | $\begin{aligned} & \pm 1.1 \\ & \pm 5.0 \end{aligned}$ |  | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |

The $\bullet$ denotes specifications which apply over the full operating temperature range; all other limits and typicals are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.
Note 2: Connecting any input terminal to voltages greater than $\mathrm{V}^{+}$or less than ground may cause destructive latch-up. It is recommended that no inputs from source operating from external supplies be applied prior to power-up of the LTC660.
Note 3: The output resistance is a combination of internal switch resistance and external capacitor ESR. To maximize output voltage and efficiency, keep external capacitor ESR $<0.2 \Omega$.

Note 4: fosc is tested with $\mathrm{C}_{O S C}=100 \mathrm{pF}$ to minimize the effects of test fixture capacitance loading. The 0pF frequency is correlated to this 100pF test point, and is intended to simulate the capacitance at Pin 7 when the device is plugged into a test socket and no external capacitor is used.
Note 5: OUT may be shorted to GND for 1 sec without damage, but shorting OUT to $\mathrm{V}^{+}$may damage the device and should be avoided. Also, for temperatures above $85^{\circ} \mathrm{C}$, OUT must not be shorted to GND or $\mathrm{V}^{+}$, even instantaneously, or device damage may result.

## TYPICAL PERFORMANCE CHARACTERISTICS (Using Test tirutitit figure 1)



## TYPICAL PGRFORMANCE CHARACTERISTICS (Using Test Ciruuit in figure 1)


Oscillator Frequency
vs Supply Voltage


LTC660•TPC13

 vs Supply Voltage



LTC660•TPC12

## Oscillator Frequency vs Temperature


LTC660•TPC14


LTC660 • TPC16

## Oscillator Frequency

vs External Capacitance

LTC660•TPC17

## PIn functions

| PIN | NAME | INVERTER | DOUBLER |
| :---: | :---: | :---: | :---: |
| 1 | BOOST | Internal Oscillator Frequency Control Pin. <br> BOOST $=$ Open, $\mathrm{f}_{0 \mathrm{C}}=10 \mathrm{kHz}$ typ; <br> BOOST $=\mathrm{V}^{+}, \mathrm{f}_{\text {OSC }}=80 \mathrm{kHz}$ typ; when OSC is driven externally BOOST has no effect. | Same |
| 2 | CAP ${ }^{+}$ | Positive Terminal for Charge Pump Capacitor | Same |
| 3 | GND | Power Supply Ground Input | Positive Voltage Input |
| 4 | CAP ${ }^{-}$ | Negative Terminal for Charge Pump Capacitor | Same |
| 5 | Vout | Negative Voltage Output | Power Supply Ground Input |
| 6 | LV | Tie LV to GND when the input voltage is less than 3 V . LV may be connected to GND or left open for input voltages above 3 V . Connect LV to GND when overdriving OSC. | LV must be tied to $\mathrm{V}_{\text {OUT }}$ for all input voltages. |
| 7 | OSC | An external capacitor can be connected to this pin to slow the oscillator frequency. Keep stray capacitance to a minimum. An external oscillator can be applied to this pin to overdrive the internal oscillator. | Same except standard logic levels will not be able to overdrive OSC pin. |
| 8 | V+ | Positive Voltage Input | Positive Voltage Output |



Figure 1. Test Circuit

## LTC660

## APPLICATIONS INFORMATION

## Theory of Operation

To understand the theory of operation for the LTC660, a review of a basic switched-capacitor building block is helpful. In Figure 2, when the switch is in the left position, capacitor C 1 will charge to voltage V1. The total charge on C 1 will be q1 = C1V1. The switch then moves to the right, discharging C 1 to voltage V 2 . After this discharging time, the charge on C1 is q2 $=\mathrm{C} 1 \mathrm{~V} 2$. Note that charge has been transferred from the source V1 to the output V2. The amount of charge transferred is:

$$
\Delta q=q 1-q 2=C 1(V 1-V 2)
$$

If the switch is cycled " $f$ " times per second, the charge transfer per unit time (i.e., current) is:

$$
I=f \bullet \Delta q=f \bullet C 1(V 1-V 2)
$$

Rewriting in terms of voltage and impedance equivalence,

$$
I=\frac{V 1-V 2}{1 / f C 1}=\frac{V 1-V 2}{R_{E Q U I V}}
$$

A new variable $R_{\text {EQUIV }}$ has been defined such that $R_{\text {EQUIV }}=1 / \mathrm{fC1}$. Thus, the equivalent circuit for the switchedcapacitor network is as shown in Figure 3.

Figure 4 shows that the LTC660 has the same switching action as the basic switched-capacitor building block.


Figure 2. Switched-Capacitor Building Block


Figure 3. Switched-Capacitor Equivalent Circuit


Figure 4. LTC660 Switched-Capacitor Voltage Converter Block Diagram

This simplified circuit does not include finite on-resistance of the switches and output voltage ripple, however, it does give an intuitive feel for how the device works. For example, if you examine power conversion efficiency as a function of frequency this simple theory will explain how the LTC660 behaves. The loss and hence the efficiency is set by the output impedance. As frequency is decreased, the output impedance will eventually be dominated by the 1/fC1 term and voltage losses will rise decreasing the efficiency. As the frequency increases the quiescent current increases. At high frequency this current loss becomes significant and the power efficiency starts to decrease.

The LTC660 oscillator frequency is designed to run where the voltage loss is a minimum. With the external $150 \mu \mathrm{~F}$ capacitors the effective output impedance is determined by the internal switch resistances and the capacitor ESRs.

## LV (Pin 6)

The internal logic of the LTC660 runs between $\mathrm{V}^{+}$and LV (Pin 6). For $\mathrm{V}^{+} \geq 3 \mathrm{~V}$, an internal switch shorts LV to ground (Pin 3). For $\mathrm{V}^{+}<3 \mathrm{~V}$, the LV pin should be tied to ground. For $\mathrm{V}^{+} \geq 3 \mathrm{~V}$, the LV pin can betied to ground or left floating.

## OSC (Pin 7) and BOOST (Pin 1)

The switching frequency can be raised, lowered or driven from an external source. Figure 5 shows a functional diagram of the oscillator circuit.

## APPLICATIONS INFORMATION



Figure 5. Oscillator
By connecting the BOOST pin (Pin 1) to $\mathrm{V}^{+}$, the charge and discharge current is increased and, hence, the frequency is increased by approximately four and a half times. Increasing the frequency will decrease output impedance and ripple for high load currents.

Loading Pin 7 with more capacitance will lower the frequency. Using the BOOST (Pin 1) in conjunction with external capacitance on Pin 7 allows user selection of the frequency over a wide range.

Driving the LTC660 from an external frequency source can be easily achieved by driving Pin 7 and leaving the BOOST pin open, as shown in Figure 6. The output current from Pin 7 is small, typically $1.1 \mu \mathrm{~A}$ to $8 \mu \mathrm{~A}$, so a logic gate is capable of driving this current. (A CMOS logic gate can be used to drive the OSC pin.) For 5V applications, a TTL logic gate can be used by simply adding an external pull-up resistor (see Figure 6).


Figure 6. External Clocking

## Capacitor Selection

While the exact values of C1 and C2 are noncritical, good quality, low ESR capacitors are necessary to minimize voltage losses at high currents. For C1 the effect of the ESR of the capacitor will be multiplied by four, due to the fact the switch currents are approximately two times higher than the output current and losses will occur on both the charge and discharge cycle. This means using a capacitor with $1 \Omega$ of ESR for C1 will have the same effect as increasing the output impedance of the LTC660 by $4 \Omega$. This represents a significant increase in the voltage losses. For C 2 the effect of ESR is less dramatic. A C2 with $1 \Omega$ of ESR will increase the output impedance by $1 \Omega$. The size of C 2 and the load current will determine the output voltage ripple. It is alternately charged and discharged at a current approximately equal to the output current. This will cause a step function to occur in the output voltage at the switch transitions. For example, for a switching frequency of 5 kHz (one-half the nominal 10 kHz oscillator frequency) and $\mathrm{C} 2=150 \mu \mathrm{~F}$ with an ESR of $0.2 \Omega$, ripple is approximately 90 mV with a 100 mA load current.

## TYPICAL APPLICATIONS

## Negative Voltage Converter

Figure 7 shows a typical connection which will provide a negative supply from an available positive supply. This circuit operates over full temperature and power supply ranges without the need of any external diodes. The LV pin (Pin 6) is shown grounded, but for $\mathrm{V}^{+} \geq 3 \mathrm{~V}$, it may be floated, since LV is internally switched to ground (Pin 3) for $\mathrm{V}^{+} \geq 3 \mathrm{~V}$.


Figure 7. Voltage Inverter
The output voltage (Pin 5) characteristics of the circuit are those of a nearly ideal voltage source in series with a $6.5 \Omega$ resistor. The $6.5 \Omega$ output impedance is composed of two terms: 1) the equivalent switched-capacitor resistance (see Theory of Operation), and 2) a term related to the onresistance of the MOS switches.

At an oscillator frequency of 10 kHz and $\mathrm{C} 1=150 \mu \mathrm{~F}$, the first term is:

$$
\begin{aligned}
& \mathrm{R}_{\text {EQUIV }}=\frac{1}{\left(\mathrm{f}_{\text {OSC }} / 2\right) \mathrm{C1}}= \\
& \frac{1}{5 \cdot 10^{3} \cdot 150 \cdot 10^{-6}}=1.3 \Omega .
\end{aligned}
$$

Notice that the equation for REQUIV is not a capacitive reactance equation ( $X_{C}=1 / \omega C$ ) and does not contain a $2 \pi$ term.

The exact expression for output impedance is complex, but the dominant effect of the capacitor is clearly shown on the typical curves of output impedance and power efficiency versus frequency. For $\mathrm{C} 1=\mathrm{C} 2=150 \mu \mathrm{~F}$, the output impedance goes from $6.5 \Omega$ at $f_{\text {OSC }}=10 \mathrm{kHz}$ to $110 \Omega$ at $\mathrm{f}_{0 S C}=100 \mathrm{~Hz}$. As the $1 / \mathrm{fC}$ term becomes large compared to the switch on-resistance term, the output resistance is determined by 1/fC only.

## Voltage Doubling

Figure 8 shows the LTC660 operating in the voltage doubling mode. The external Schottky (1N5817) diode is for start-up only. The output voltage is $2 \cdot \mathrm{~V}_{\mathrm{IN}}$ without a load. The diode has no effect on the output voltage.


Figure 8. Voltage Doubler

## Ultraprecision Voltage Divider

An ultraprecision voltage divider is shown in Figure 9. To achieve the $0.002 \%$ accuracy indicated, the load current should be kept below 100nA. However, with a slight loss in accuracy, the load current can be increased.


Figure 9. Ultraprecision Voltage Divider

## Battery Splitter

A common need in many systems is to obtain positive and negative supplies from a single battery or single power supply system. Where current requirements are small, the circuit shown in Figure 10 is a simple solution. It provides symmetrical positive or negative output voltages, both equal to one-half the input voltage. The output voltages are both referenced to Pin 3 (Output Common).

## TYPICAL APPLICATIONS



Figure 10. Battery Splitter

## Paralleling for Lower Output Resistance

Additional flexibility of the LTC660 is shown in Figures 11 and 12. Figure 11 shows two LTC660s connected in parallel to provide a lower effective output resistance. If, however, the output resistance is dominated by $1 / \mathrm{fC} 1$, increasing the capacitor size (C1) or increasing the frequency will be of more benefit than the paralleling circuit shown.

## Stacking for Higher Voltage

Figure 12 makes use of "stacking" two LTC660s to provide even higher voltages. In Figure 12, a negative voltage doubler or tripler can be achieved depending upon how Pin 8 of the second LTC660 is connected, as shown schematically by the switch.


Figure 11. Paralleling for 200mA Load Current


Figure 12. Stacking for High Voltage

PACKAGE DESCRIPTION Dimensions in incheses miliumeers) unless othemisis noted.

N8 Package
8-Lead PDIP (Narrow 0.300)
(LTC DWG \# 05-08-1510)

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH ( 0.254 mm )

PACKAGE DESCRIPTION Dimensions in incteses miliumeers) unless otiemisis noted.

## S8 Package

8-Lead Plastic Small Outline (Narrow 0.150)
(LTC DWG \# 05-08-1610)


## TYPICAL APPLICATIONS



Voltage Doubler


## RELATED PARTS

| PART NUMBER | OUTPUT CURRENT | MAXIMUM VIN | COMMENTS |
| :--- | :---: | :---: | :--- |
| Unregulated Output Voltage |  |  |  |
| LTC660 | 100 mA | 6 V | Highest Current |
| LTC1046 | 50 mA | 6 V |  |
| LTC1044 | 20 mA | 9.5 V | Lowest Cost |
| LTC1044A | 20 mA | 13 V |  |
| LTC1144 | 20 mA | 20 V | Highest Voltage |
| Regulated Output Voltage | 100 mA | 16 V | Adjustable Output |
| LT1054 | 30 mA | 6 V | 12 V Fixed Output |
| LTC1262 | 10 mA | 9 V | $-4 \mathrm{~V},-4.5 \mathrm{~V}$ and Adjustable <br> LTC1261 |

All devices are available in plastic 8-lead SO and PDIP packages

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